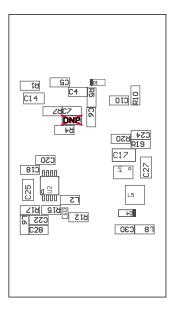


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: Final TIDA-00237-E2

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00237	REV: E2	SVN REV	: Not In VersionControl
PLOT NAME = Top Assembly Drawing	GENERATED : 3/13/2	015 5:02:21	AM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: Final TIDA-00237-E2

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00237	REV: E2	SVN REV: Not In VersionControl
PLOT NAME = Bottom Assembly Drawing	GENERATED : 3/13/2	015 5:02:27	AM TEXAS INSTRUMENTS

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